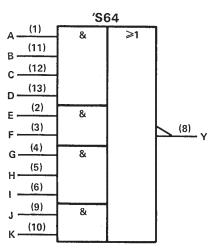
- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

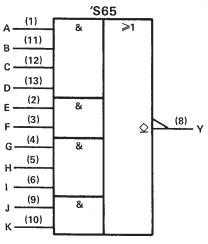
description

These devices contain 4-2-3-2 input AND-OR-INVERT gates. They perform the Boolean function $Y = \overline{ABCD + EF + GHI + JK}$. The 'S64 has totem-pole outputs and the 'S65 has open-collector outputs.

The SN54S64 and the SN54S65 are characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN74S64 and the SN74S65 are characterized for operation from 0 °C to 70 °C.

logic symbols[†]





[†]These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

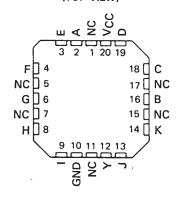
Pin numbers shown are for D, J, N, and W packages.



| SN54S64, | SN54S65 | | . J | OR | W | PACKAGE | |
|----------|---------|-----|-----|----|---|---------|--|
| SN74S64, | SN74S65 | • • | . D | OR | Ν | PACKAGE | |
| | (TOP | VI | EW |) | | | |

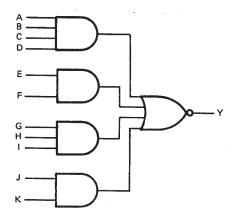
A 1 14 VCC E 2 13 D F 3 12 C G 4 11 B H 5 10 K I 6 9 J GND 7 8 Y

SN54S64, SN54S65 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

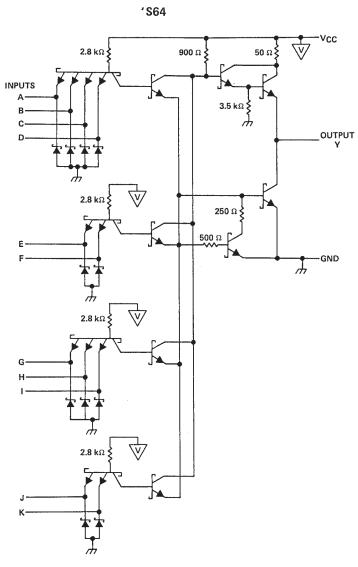
logic diagram (each device) (positive logic)

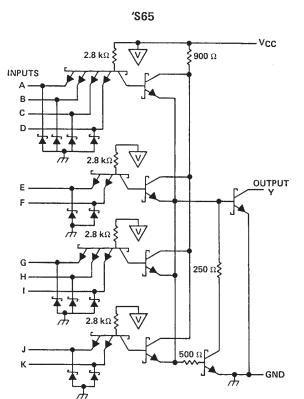


SN54S64, SN54S65, SN74S64, SN74S65 4-2-3-2 INPUT AND-OR-INVERT GATES

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schematics (each gate)





Resistor values shown are nominal and in ohms.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) | | |
|--|-------|-----------------|
| Input voltage | | |
| Off-state output voltage, 'S65 | | |
| Operating free-air temperature range: \$ | SN54' | |
| | | 0°C to 70°C |
| | | – 65°C to 150°C |



SN54S64, SN54S65 4-2-3-2 INPUT AND-OR-INVERT GATES

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Į

recommended operating conditions

| | S | SN54S6 | 4 | SN74S64 | | | |
|---|------|--------|-----|---------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| V _{CC} Supply voltage | 4.5 | 5 | 5,5 | 4.75 | 5 | 5.25 | V |
| VIH High-level input voltage | 2 | | | 2 | | | v |
| VIL Low-level input voltage | | | 0,8 | | | 0,8 | V |
| IOH High-level output current | | | - 1 | | | - 1 | mA |
| IOL Low-level output current | | | 20 | | | 20 | mA |
| T _A Operating free-air temperature | - 55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

1

| PARAMETER | TEST CONDITIONS t | | | | | | | | | |
|-----------|------------------------|--------------------------|--------------------------|------|------|-------|------|------|-------|------|
| | | | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | UNIT |
| VIK | V _{CC} = MIN, | l _l = – 18 mA | | | | - 1,2 | | | - 1.2 | V |
| VOH | $V_{CC} = MIN,$ | V _{IL} = 0.8 V, | I _{OH} = - 1 mA | 2.5 | 3.4 | | 2.7 | 3.4 | | V |
| VOL | $V_{CC} = MIN,$ | V _{IH} = 2 V, | 1 _{OL} = 20 mA | | | 0.5 | | | 0.5 | V |
| <u> </u> | $V_{CC} = MAX,$ | V ₁ = 5.5 V | | | | 1 | | | 1 | mA |
| Чн | $V_{CC} = MAX,$ | V ₁ = 2.7 V | | | | 50 | | | 50 | μA |
| hL hL | $V_{CC} = MAX$, | V ₁ = 0.5 V | | | | - 2 | | | - 2 | mA |
| los§ | V _{CC} = MAX | | | - 40 | | - 100 | - 40 | | - 100 | mA |
| Іссн | $V_{CC} = MAX,$ | V ₁ = 0 | | | 7 | 12.5 | | 7 | 12,5 | mA |
| CCL | V _{CC} = MAX, | V ₁ = 4.5 V | | | 8.5 | 16 | | 8.5 | 16 | mA |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. §Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CON | TEST CONDITIONS | | МАХ | UNIT |
|------------------|-----------------|----------------|-------------------------|------------------------|-----|-----|------|
| ^t PLH | | | P 290 O | 0 15 - 5 | 3.5 | 5.5 | ns |
| ^t PHL | Any | v | R _L = 280 Ω, | C _L = 15 pF | 3.5 | 5.5 | ns |
| ^t PLH | 7.07 | | R. = 280 O | C. = E0 = E | 5 | | ns |
| ^t PHL | | | R _L = 280 Ω, | C _L = 50 pF | 5.5 | | ns |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



SN54S65, SN54S65 4-2-3-2 INPUT AND-OR-INVERT GATES

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recommended operating conditions

| | | SN54S65 | | | SN74S65 | | |
|---|------|---------|-----|------|---------|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| VIH High-level input voltage | 2 | | | 2 | | | V |
| VIL Low-level input voltage | | | 0.8 | | | 0.8 | v |
| VOH High-level output voltage | | | 5.5 | | | 5.5 | V |
| OL Low-level output current | | | 20 | | | 20 | mA |
| T _A Operating free-air temperature | - 55 | | 125 | 0 | | 70 | °c |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | SN54S65 | SN74S65 | |
|-----------|--|--------------------------|--------------------------|------|
| | | MIN TYP [‡] MAX | MIN TYP [‡] MAX | UNIT |
| VIK | $V_{CC} = MIN, I_{I} = -18 \text{ mA}$ | 1.2 | 1.2 | V |
| юн | $V_{CC} = MIN, V_{IL} = 0.8 V, V_{OH} = 5.5 V$ | | 0.25 | |
| | $V_{CC} = MIN, V_{IL} = 0.7 V, V_{OH} = 5.5 V$ | 0.25 | | mA |
| VOL | $V_{CC} = MIN$, $V_{IH} = 2 V$, $I_{OL} = 20 mA$ | 0.2 0.4 | 0.2 0.4 | V |
| <u> </u> | $V_{CC} = MAX, V_I = 5.5 V$ | 1 | 1 | mA |
| liH | $V_{CC} = MAX, V_I = 2.7 V$ | 50 | 50 | μA |
| ار | $V_{CC} = MAX, V_1 = 0.5 V$ | -2 | -2 | mA |
| Іссн | $V_{CC} = MAX, V_I = 0$ | 6 11 | 6 11 | mA |
| ICCL | $V_{CC} = MAX, V_1 = 4.5 V$ | 8.5 16 | 8.5 16 | mA |

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. [‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25 °C$.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 2)

| PAR | AMETER | FROM (INPUT) | TO (OUTPUT) | TEST CON | DITIONS | MIN | түр | MAX | UNIT | |
|-----|--------|-----------------|----------------|--|------------------------|-----|-----|-----|------|----|
| t | PLH | | | B ₁ = 280 O | C ₁ = 15 pF | 2 | 5 | 7.5 | ns | |
| t | PHL | Any | · · · | $R_L = 280 \Omega,$ $R_L = 280 \Omega,$ | CL - 15 pP | 2 | 5.5 | 8.5 | ns | |
| t | PLH | | ' | • | $B_1 = 280 \text{ O}$ | | | 8 | | ns |
| t | PHL | | | RL = 280 Ω, | C _L = 50 pF | | 6.5 | | ns | |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



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